## Applications

- Mobile Phones
- Notebook PC
- Netbook Games
- **Product Features**
- ultra-thin (3 mm) module z-height
- excellent low light performance 3300 mV/lux-sec
- support for multiple interfaces including parallel and MIPI serial output 🔳 support for binning
- automatic image control functions: - automatic exposure control (AEC)
   - automatic gain control (AGC)
   - automatic white balance (AWB) - automatic band filter (ABF)
  - automatic 50/60 Hz luminance detection - automatic black level calibration (ABLC)
- programmable controls for frame rate, mirror and flip, scaling, cropping, and windowing
- image quality controls: color saturation, hue, gamma, sharpness (edge enhancement), lens correction, defective pixel canceling, and noise canceling
- support for output formats: 8/10-bit RAW RGB, CCIR656 and YUV422

- support for horizontal and vertical sub-sampling
- support for images sizes: VGA and any arbitrary size scaling down from VGA
- - support for external frame synchronization
  - standard serial SCCB interface
  - embedded one-time programmable (OTP) memory for part identification, etc.
  - on-chip phase lock loop (PLL)
  - programmable I/O drive capability
  - built-in 1.5V regulator for core

- OV07739-A34A (color, lead-free, 34-pin CSP3)
- OV07739-A34T (color, lead-free, 34-pin CSP3 high temp)

## **Product Specifications**

- active array size: 640 × 480
- power supply:
  core: 1.5 VDC ±5% (internal regulator) - analog: 2.6 - 3.0 V (2.8 V typical) - I/O: 1.7 - 3.0 V
- temperature range:
  operating: -30° C to 70° C junction temperature
- stable image: 0° C to 50° C junction temperature
- output formats: 8/10-bit RAW RGB, 8-bit YUV
- lens size: 1/7.5"
- lens chief ray angle: 27.5°
- input clock frequency: 6 27 MHz
- S/N ratio: 38 dB

(color, chip probing, 200 µm backgrinding, reconstructed wafer)

OV07739-G04A

- dynamic range: 68 dB @ 8x gain
- maximum image transfer rate:
  VGA (640 x 480): 30 fps
  QVGA (320 x 240): 60 fps
  QQVGA (160 x 120): 120 fps
- sensitivity: 3300 mV/lux-sec
- maximum exposure interval: 508 x trow
- dark current: 10 mV/s @ 60°C junction temperature
- pixel size: 3 µm x 3 µm
- image area: 2016 μm x 1488 μm
- package/die dimensions:
   CSP3: 3985 μm x 3385 μm - RW: 4000 µm x 3400 µm

## Functional Block Diagram



Omni - sion.



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